MOSFET - Power, Single N-Channel, TOLL

40 V, 0.95 mΩ, 300 A

FDBL9403-F085T6

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- AEC-Q101 Qualified and PPAP Capable
- Small Footprint (TOLL) for Compact Design
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T _J = 25°C unless otherwise noted)					
Parameter		Symbol	Value	Unit	
Drain-to-Source Voltage		V _{DSS}	40	V	
Gate-to-Source Voltage		V _{GS}	+20/-16	V	
Continuous Drain Current R _{θJC} (Notes 1, 3)	Steady	$T_{C} = 25^{\circ}C$	I _D	300	А
		T _C = 100°C		217	
Power Dissipation $R_{\theta JC}$ (Note 1)	State	$T_{C} = 25^{\circ}C$	PD	159.6	W
		$T_{C} = 100^{\circ}C$		79.8	
Continuous Drain Current R _{θJA} (Notes 1, 2, 3)	Steady	T _A = 25°C	Ι _D	50	А
		T _A = 100°C		36	
Power Dissipation $R_{\theta JA}$ (Notes 1, 2)	State	T _A = 25°C	PD	4.3	W
		$T_A = 100^{\circ}C$		2.1	1
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	3565	А
Operating Junction and Storage Temperature Range		T _J , T _{stg}	stg -55 to +175		
Source Current (Body Diode)		I _S	330	А	
Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)} = 35 A, L = 1 mH$)		E _{AS}	612.5	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.94	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	35	

 The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted. Current is limited by bondwire configuration.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

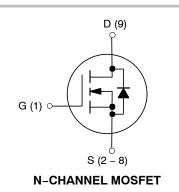
3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



ON Semiconductor®

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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	$0.95~\mathrm{m}\Omega @~10~\mathrm{V}$	300 A





ORDERING INFORMATION

Device	Package	Shipping [†]
FDBL9403-F085T6	H-PSOF8L (Pb-Free)	2000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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Table 1. ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

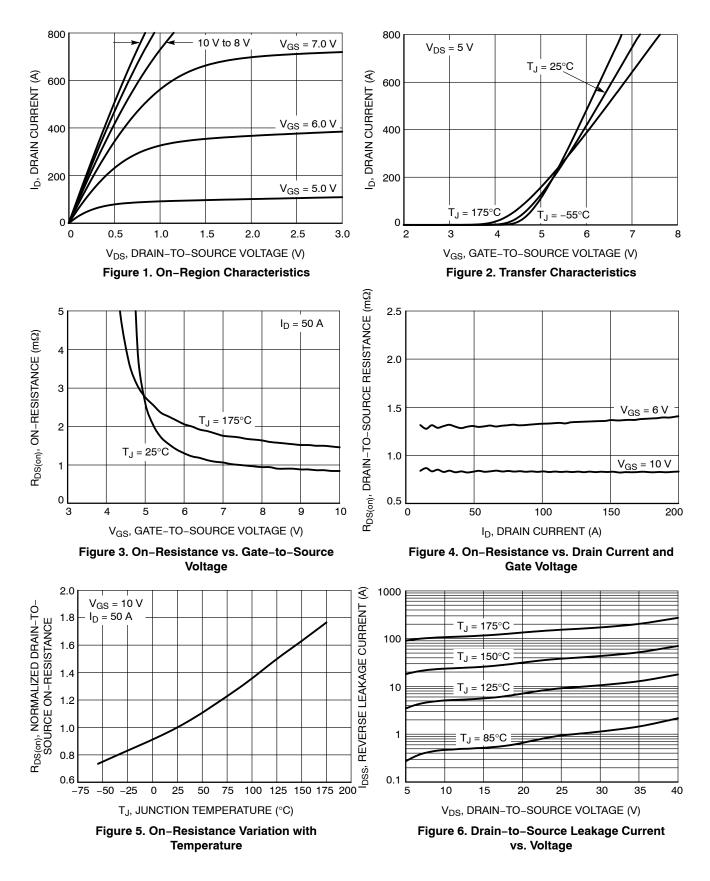
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
OFF CHARACTERISTICS	-	•		-	-	-
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J			22		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$ $T_J = 25^{\circ}\text{C}$			1	μA
		T _J = 175°C		310		μA
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 \text{ V}, \text{ V}_{GS} = +20/-16 \text{ V}$			±100	nA
ON CHARACTERISTICS (Note 4)						
Gate Threshold Voltage	V _{GS(th)}	$V_{GS}=V_{DS},I_{D}=250\;\mu\text{A}$	2	2.8	4	V
Threshold Temperature Coefficient	V _{GS(th)} /T _J			-7.1		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 10 V, I _D = 50 A		0.84	0.95	mΩ
CHARGES, CAPACITANCES & GATE F	ESISTANCE	•				
Input Capacitance	C _{iss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 100 KHz		6985		pF
Output Capacitance	C _{oss}			3720		pF
Reverse Transfer Capacitance	C _{rss}	1		68		pF
Gate Resistance	Rg	V _{GS} = 0.5 V, f = 1 MHz		1.1		Ω
Total Gate Charge	Q _{G(tot)}	V_{GS} = 10 V, V_{DS} = 20 V, I_{D} = 50 A		108		nC
Threshold Gate Charge	Q _{G(th)}	$V_{GS} = 0$ to 2 V		13		nC
Gate-to-Source Gate Charge	Q _{gs}	V _{DD} = 22 V, I _D = 50 A		28		nC
Gate-to-Drain "Miller" Charge	Q _{gd}	1		23		nC
Plateau Voltage	V _{GP}	1		4.4		V
SWITCHING CHARACTERISTICS (Note	9 5)	·		4		
Turn-On Delay Time	t _{d(on)}	V _{GS} = 10 V, V _{DD} = 20 V,		33		ns
Turn-On Rise Time	t _r	$I_D = 50 \text{ A}, \text{ R}_{\text{GEN}} = 6 \Omega$		56		ns
Turn-Off Delay Time	t _{d(off)}	1		84		ns
Turn-Off Fall Time	t _f	1		39		ns
DRAIN-SOURCE DIODE CHARACTER	ISTICS	·	•	•	-	
Source-to-Drain Diode Voltage	V _{SD}	I _{SD} = 50 A, V _{GS} = 0 V		0.79	1.2	V
Reverse Recovery Time	t _{rr}	V_{GS} = 0 V, dI _S /d _t = 100 A/µs, I _S = 50 A		84		ns
Charge Time	ta	I _S = 50 A		54		ns
Discharge Time	t _b	1		30		ns
Reverse Recovery Charge	Q _{rr}	1		172		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

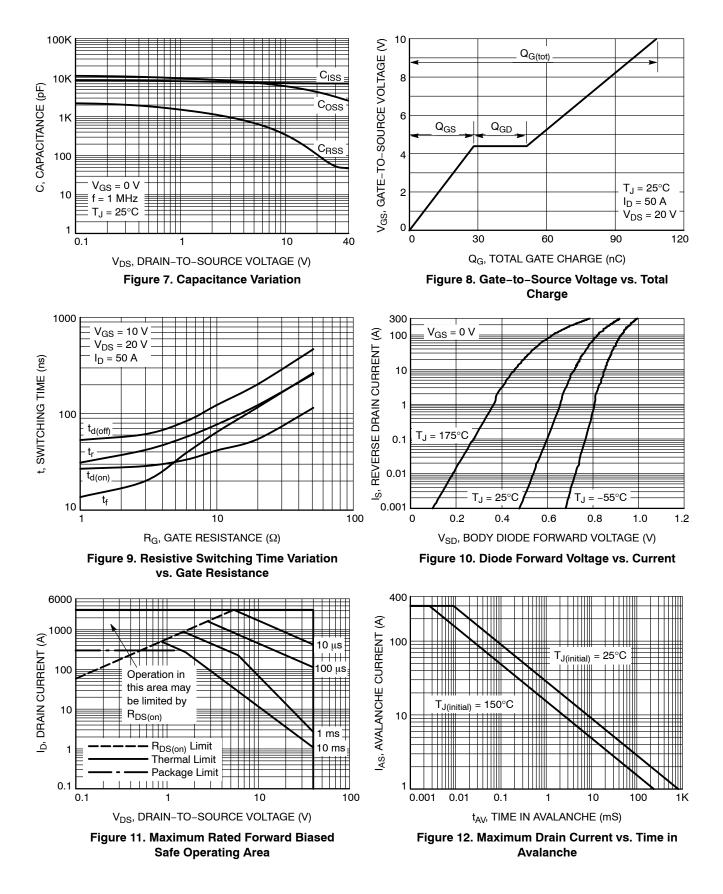
4. Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%.

5. Switching characteristics are independent of operating junction temperatures

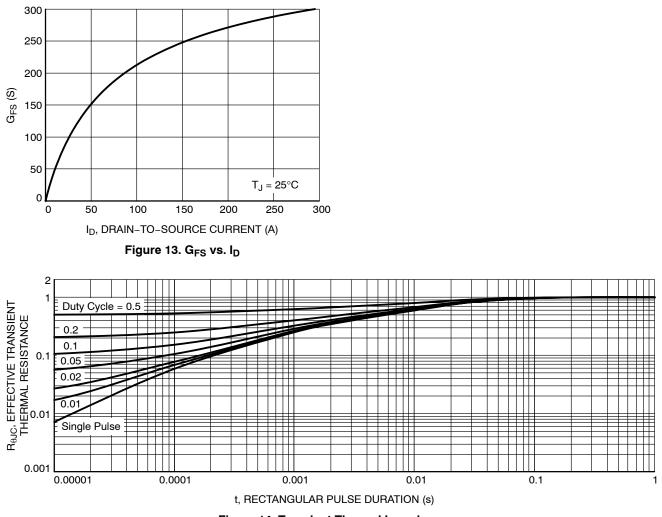
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

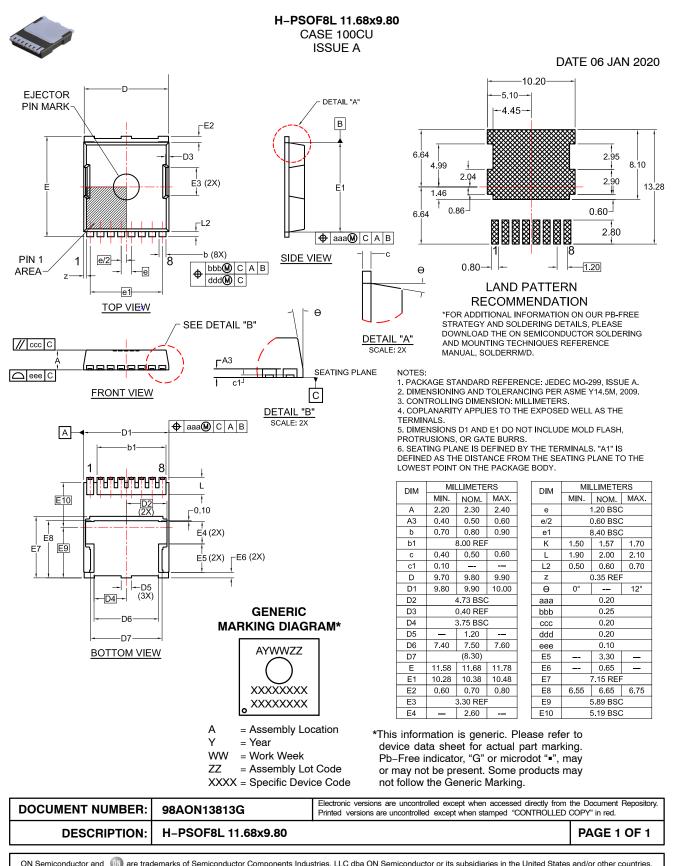


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